

BC807 BC808

Small Signal Transistors (PNP)

FEATURES

<u>SOT-23</u>

- PNP Silicon Epitaxial Planar Transistors for switching, AF driver and amplifier applications.
- Especially suited for automatic insertion in thick- and thin-film circuits.
- These transistors are subdivided into three groups -16, -25 and -40 according to their current gain.
- As complementary types, the NPN transistors BC817 and BC818 are recommended.
- ♦ AEC-Q101 qualified

MECHANICAL DATA

Case: SOT-23 Plastic Package Weight: approx. 0.008 g Marking code

Туре	Marking		
BC807-16	5A		
-25	5B		
-40	5C		
BC808-16	5E		
-25	5F		
-40	5G		



Dimensions in inches and (millimeters)

Pin configuration

1 = Base, 2 = Emitter, 3 = Collector.

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS Ratings at 25 °C ambient temperature unless otherwise specified

		Symbol	Value	Unit
Collector-Emitter Voltage	BC807 BC808	-V _{CES} -V _{CES}	50 30	V V
Collector-Emitter Voltage	BC807 BC808	–V _{CEO} –V _{CEO}	45 25	V V
Emitter-Base Voltage		-V _{EBO}	5	V
Collector Current		-I _C	500	mA
Peak Collector Current		-I _{CM}	1000	mA
Peak Base Current		-I _{BM}	200	mA
Peak Emitter Current		I _{EM}	1000	mA
Power Dissipation at T _{SB} = 50 °C		P _{tot}	310 ¹⁾	mW
Junction Temperature		Tj	150	°C
Storage Temperature Range		T _S	-65 to +150	°C
¹⁾ Device on fiberglass substrate, see layout		· · · · · ·		

ELECTRICAL CHARACTERISTICS Ratings at 25 °C ambient temperature unless otherwise specified

	Symbol	Min.	Тур.	Max.	Unit
DC Current Gain at $-V_{CE} = 1 \text{ V}, -I_{C} = 100 \text{ mA}$ Current Gain Group-16 -25 -40 at $-V_{CE} = 1 \text{ V}, -I_{C} = 300 \text{ mA}$ -16 -25 -40	hfe hfe hfe hfe hfe hfe	100 160 250 60 100 170	- - - - -	250 400 600 	
Thermal Resistance Junction Substrate Backside	R _{thSB}	-	_	320 ¹⁾	K/W
Thermal Resistance Junction to Ambient Air	R _{thJA}	-	_	450 ¹⁾	K/W
Collector Saturation Voltage at $-I_C = 500 \text{ mA}$, $-I_B = 50 \text{ mA}$	-V _{CEsat}	-	_	0.7	V
Base-Emitter Voltage at –V _{CE} = 1 V, –I _C = 300 mA	–V _{BE}	-	_	1.2	V
	-I _{CES} -I _{CES} -I _{CES}		_ _ _	100 100 5	nA nA μA
Emitter-Base Cutoff Current at $-V_{EB} = 4 V$	–I _{EBO}	-	_	100	nA
Gain-Bandwidth Product at $-V_{CE} = 5 \text{ V}$, $-I_{C} = 10 \text{ mA}$, f = 50 MHz	f _T	_	100	-	MHz
Collector-Base Capacitance at $-V_{CB} = 10 \text{ V}$, f = 1 MHz	C _{CBO}		12		pF
1) Device en fibergless substrate see leveut					

¹⁾ Device on fiberglass substrate, see layout

Layout for R_{thJA} test



Thickness: Fiberglass 0.059 in (1.5 mm) Copper leads 0.012 in (0.3 mm)



RATING AND CHARACTERISTICS CURVES (BC807/ BC808)

Admissible power dissipation versus temperature of substrate backside Device on fiberglass substrate, see layout Collector current versus base-emitter voltage



Pulse thermal resistance versus pulse duration (normalized) Device on fiberglass substrate, see layout





Gain-bandwidth product versus collector current



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RATING AND CHARACTERISTICS CURVES (BC807/ BC808)

Collector saturation voltage versus collector current

DC current gain versus collector current



Base saturation voltage versus collector current





Common emitter collector characteristics







RATING AND CHARACTERISTICS CURVES (BC807/ BC808)

Common emitter collector characteristics





Common emitter collector characteristics

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PACKAGING OF DIODE

REEL PACK

PACKAGE	PACKING	REEL	COMPONENT	TAPE SPACE	REEL DIA	CARTON SIZE	EA PER	GROSS
	CODE	(EA)	SPACE(mm)	(mm)	(mm)	(mm)	CARTON	WEIGHT(Kg)
SOT-23/-3L	-T	3,000			178	438*438*220	180,000	

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